ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	PC. Bannockl	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration	ion of the s encompasse	ubstances es all lowe	within the n r level mater	nanufacture rials for wh	er listed iten hich the mar	n. Note: i iufacture	if the item is an as r has engineering	sembly with low responsibility.	
	21.1 IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					ls and Mfg	s and Mfg Information			
Supplier Information															
Company name* Co			Company unique ID			Unique ID Authority					Response Date*				
nsemi											2024-05-21				
Contact Name	tact Name Title - Contact					Phone - Contact*					Email - Contact*				
Product-Env-Stewards Product Enviro			viro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			entative		Phone - Representative*				Email - Representative*						
Product-Env-Stewards Product Envi			wiro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iten	Number	Mfr Item Name			Effective Date	e Version]	Manufacturing Site		We	ight*	UOM	Unit Type	
	CAT240	CAT24C08C5ATR 8KB I2C SER EE		EPROM	I 202				CNQ		0.4	84	mg	Each	
Ianufacturing Proccess Informa	tion					·									
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature M		re Max Tin	e at Peak Temperat		e Numl	ber of Reflow Cyc	eles		
SnAgCu CU Alloy			1		260		С	30		seconds	3				
omments															
vel 1 - maximum time at peak temperat	ure during so	Idering is 10-3	0 seconds												
or more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless	cable [E] enter the weigh	, Requester or Supplier) [B It of the substance or the Pl] select the subst PM concentration	ance category (JIG or Requester) or [F] Optionally enter the positive (-	enter a value (Supplier). [C] se -) and negative (-) tolerance in J	lect the substance (J) percent (Note: percer	G) or enter the substa at tolerance values are	nce and CAS (Other). [D] expected to cover a 3
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.387	mg	Supplier	Silicon (Si)	7440-21-3		0.387	mg
RDL	0.005	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0049	mg
Solder Ball	0.085	mg	Supplier	Silver (Ag)	7440-22-4		0.0022	mg
			Supplier	Tin (Sn)	7440-31-5		0.0823	mg
			Supplier	Copper (Cu)	7440-50-8		0.0005	mg
Under Bump Metal	0.007	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0069	mg